Octal Schmitt trigger buffer/line driver; 3-state; inverting Rev. 4 — 31 December 2012 Product data

Product data sheet

1. **General description**

The 74HC7540; 74HCT7540 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7A.

The 74HC7540; 74HCT7540 provides eight inverting buffer/line drivers with 3-state outputs and Schmitt-trigger action. The 3-state outputs are controlled by the output enable inputs OE1 and OE2. A HIGH on OEn causes the outputs to assume a high-impedance OFF-state. Schmitt trigger action on the data inputs transforms slowly changing input signals into sharply defined, jitter-free output signals.

The 74HC7540; 74HCT7540 is identical to the 74HC540; 74HCT540 but has hysteresis on the data inputs.

2. **Features and benefits**

- Inverting outputs
- Low-power dissipation
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

Ordering information 3.

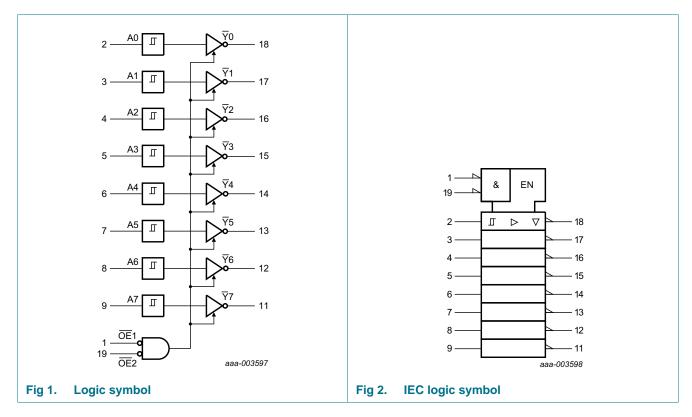
Table 1. **Ordering information**

| Type number | Package | Package | | | | | | | | |
|-------------|-------------------|---------|--|----------|--|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | | |
| 74HC7540N | –40 °C to +125 °C | DIP20 | plastic dual in-line package; 20 leads (300 mil) | SOT146-1 | | | | | | |
| 74HCT7540N | | | | | | | | | | |
| 74HC7540D | –40 °C to +125 °C | SO20 | plastic small outline package; 20 leads; | SOT163-1 | | | | | | |
| 74HCT7540D | | | body width 7.5 mm | | | | | | | |
| 74HC7540DB | –40 °C to +125 °C | SSOP20 | plastic shrink small outline package; 20 leads; body width 5.3 mm | SOT339-1 | | | | | | |

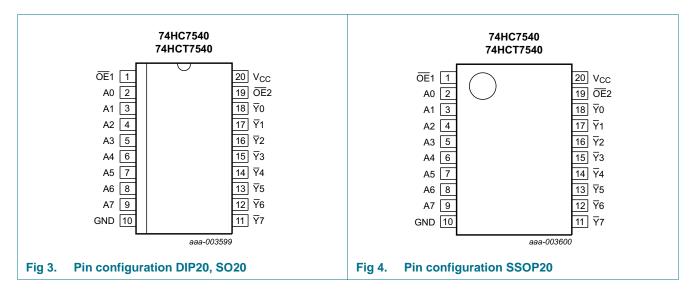


Octal Schmitt trigger buffer/line driver; 3-state; inverting

4. Functional diagram



5. Pinning information



5.1 Pinning

Octal Schmitt trigger buffer/line driver; 3-state; inverting

5.2 Pin description

| Table 2. | Pin description | |
|------------------------------------|--------------------------------|----------------------------------|
| Symbol | Pin | Description |
| OE1 | 1 | output enable input (active LOW) |
| A0 to A7 | 2, 3, 4, 5, 6, 7, 8, 9 | data input |
| GND | 10 | ground (0 V) |
| $\overline{Y}0$ to $\overline{Y}7$ | 18, 17, 16, 15, 14, 13, 12, 11 | data output |
| OE2 | 19 | output enable input (active LOW) |
| V _{CC} | 20 | supply voltage |

6. Functional description

Table 3. Functional table^[1]

| Control | | Input | Output |
|---------|-----|-------|--------|
| OE1 | OE2 | An | Yn |
| L | L | L | Н |
| L | L | Н | L |
| Х | Н | Х | Z |
| Н | Х | Х | Z |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| nbol | Parameter | Conditions | Min | Max | Unit |
|------|-------------------------|---|--------------|------|------|
| > | supply voltage | | -0.5 | +7 | V |
| | input clamping current | $V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V | <u>[1]</u> _ | ±20 | mA |
| | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V | <u>[1]</u> _ | ±20 | mA |
| | output current | $-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ | - | ±35 | mA |
| | supply current | | - | 70 | mA |
| D | ground current | | -70 | - | mA |
| J | storage temperature | | -65 | +150 | °C |
| | total power dissipation | | [2] | | |
| | DIP20 | | - | 750 | mW |
| | SO20, SSOP20 | | - | 500 | mW |
| | DIP20 | | | | |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For DIP20 packages: above 70 °C the value of P_{tot} derates linearly with 12 mW/K.

For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For SSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

Octal Schmitt trigger buffer/line driver; 3-state; inverting

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

| Symbol | Parameter | Conditions | 74HC7540 | | | 74HCT7540 | | | Unit |
|------------------|---------------------|------------|----------|-----|-----------------|-----------|-----|-----------------|------|
| | | | Min | Тур | Max | Min | Тур | Max | |
| V _{CC} | supply voltage | | 2.0 | 5.0 | 6.0 | 4.5 | 5.0 | 5.5 | V |
| VI | input voltage | | 0 | - | V _{CC} | 0 | - | V_{CC} | V |
| Vo | output voltage | | 0 | - | V_{CC} | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | +25 | +125 | -40 | +25 | +125 | °C |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | T _{ar} | _{nb} = 25 | °C | | : –40 °C 85 °C | | -40 °C 25 °C | Unit |
|-----------------|-----------------------------|---|-----------------|--------------------|------|------|-------------------|-----|-----------------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HC754 | 40 | | | | | | | | | |
| V _{OH} | HIGH-level | $V_I = V_{T+} \text{ or } V_{T-}$ | | | | | | | | |
| | output voltage | $I_O = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$ | 1.9 | 2.0 | - | 1.9 | - | 1.9 | - | V |
| | | $I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$ | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | $I_O = -20 \ \mu\text{A}; \ V_{CC} = 6.0 \ \text{V}$ | 5.9 | 6.0 | - | 5.9 | - | 5.9 | - | V |
| | | I_{O} = -6.0 mA; V_{CC} = 4.5 V | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |
| | | $I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$ | 5.48 | 5.81 | - | 5.34 | - | 5.2 | - | V |
| V _{OL} | LOW-level | $V_I = V_{T+} \text{ or } V_{T-}$ | | | | | | | | |
| | output voltage | $I_O = 20 \ \mu\text{A}; \ V_{CC} = 2.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 20 \ \mu A; V_{CC} = 4.5 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | $I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$ | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | I_0 = 6.0 mA; V_{CC} = 4.5 V | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| | | I_0 = 7.8 mA; V_{CC} = 6.0 V | - | 0.16 | 0.26 | - | 0.33 | - | 0.4 | V |
| l _l | input leakage current | $V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μA |
| I _{OZ} | OFF-state output current | per input pin; $V_I = V_{T+}$ or V_{T-} ; $V_O = V_{CC}$ or GND; other inputs at V_{CC} or GND; $V_{CC} = 6.0 \text{ V}$; $I_O = 0 \text{ A}$ | - | - | ±0.5 | - | ±5.0 | - | ±10 | μA |
| I _{CC} | supply current | $V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V | - | - | 8.0 | - | 80 | - | 160 | μΑ |
| Cı | input capacitance | | - | 3.5 | - | - | - | - | - | pF |
| 74HCT7 | 540 | | | | | | | | | |
| V _{OH} | HIGH-level | V_{I} = V_{T+} or $V_{T-};V_{CC}$ = 4.5 V | | | | | | | | |
| | output voltage | I _O = -20 μA | 4.4 | 4.5 | - | 4.4 | - | 4.4 | - | V |
| | | I _O = -6.0 mA | 3.98 | 4.32 | - | 3.84 | - | 3.7 | - | V |

74HC_HCT7540 Product data sheet

74HC7540; 74HCT7540

Octal Schmitt trigger buffer/line driver; 3-state; inverting

| Symbol | Parameter | Conditions | Tai | _{mb} = 25 | °C | | : –40 °C 85 °C | | : –40 °C ∣25 °C | Unit |
|--|-----------------------------|--|-----|--------------------|------|-----|-------------------|-----|--------------------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| V _{OL} | LOW-level | V_{I} = V_{T+} or $V_{T-};V_{CC}$ = 4.5 V | | | | | | | | |
| | output voltage | I _O = 20 μA; | - | 0 | 0.1 | - | 0.1 | - | 0.1 | V |
| | | l _O = 6.0 mA; | - | 0.15 | 0.26 | - | 0.33 | - | 0.4 | V |
| I _I | input leakage current | $V_1 = V_{CC}$ or GND; $V_{CC} = 5.5$ V | - | - | ±0.1 | - | ±1.0 | - | ±1.0 | μA |
| I _{OZ} | OFF-state output current | per input pin; $V_I = V_{T+}$ or V_{T-} ; $V_O = V_{CC}$ or GND; other inputs at V_{CC} or GND; $V_{CC} = 5.5 \text{ V}$; $I_O = 0 \text{ A}$ | - | - | ±0.5 | - | ±5.0 | - | ±10 | μΑ |
| I _{CC} | supply current | | - | - | 8.0 | - | 80 | - | 160 | μA |
| ΔI _{CC} additional supply curre | | per input pin; I _O = 0 A; V _I = V _{CC} - 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V | | | | | | | | |
| | | An input | - | 20 | 72 | - | 90 | - | 98 | μA |
| | | OEn input | - | 130 | 468 | - | 585 | - | 637 | μA |
| CI | input capacitance | | - | 3.5 | - | - | - | - | - | pF |

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $GND = 0 V; C_L = 50 pF;$ for test circuit see <u>Figure 7</u>.

| Symbol | Parameter | Conditions | | Tar | _{nb} = 25 | °C | T _{amb} = -40 ° | °C to +125 °C | Unit |
|------------------|-------------------|---|-----|-----|--------------------|-----|--------------------------|---------------|------|
| | | | | Min | Тур | Max | Max (85 °C) | Max (125 °C) | |
| 74HC754 | 40 | | | | | | | | |
| t _{pd} | propagation delay | An to Yn; see Figure 5 | [1] | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 39 | 120 | 150 | 180 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 14 | 24 | 30 | 36 | ns |
| | | $V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 11 | - | - | - | ns |
| | | $V_{CC} = 6.0 V$ | | - | 11 | 20 | 26 | 31 | ns |
| t _{en} | enable time | OEn to Yn; see Figure 6 | [1] | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 41 | 150 | 190 | 225 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 15 | 30 | 38 | 45 | ns |
| | | $V_{CC} = 6.0 V$ | | - | 12 | 26 | 33 | 38 | ns |
| t _{dis} | disable time | OEn to Yn; see Figure 6 | [1] | | | | | | |
| | | $V_{CC} = 2.0 V$ | | - | 52 | 150 | 190 | 225 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 19 | 30 | 38 | 45 | ns |
| | | $V_{CC} = 6.0 V$ | | - | 15 | 26 | 33 | 38 | ns |

Octal Schmitt trigger buffer/line driver; 3-state; inverting

| Symbol | Parameter | Conditions | | Tar | _{nb} = 25 | °C | T _{amb} = -40 ° | C to +125 °C | Unit |
|------------------|-------------------------------|---|-----|-----|--------------------|-----|--------------------------|--------------|------|
| | | | | Min | Тур | Max | Max (85 °C) | Max (125 °C) | |
| tt | transition time | see Figure 5 | [2] | | | | ' | | |
| | | $V_{CC} = 2.0 V$ | | - | 14 | 60 | 75 | 90 | ns |
| | | $V_{CC} = 4.5 V$ | | - | 5 | 12 | 15 | 18 | ns |
| | | $V_{CC} = 6.0 V$ | | - | 4 | 10 | 13 | 15 | ns |
| C _{PD} | power dissipation capacitance | per package; V _I = GND to V _{CC} | [3] | - | 29 | - | - | - | pF |
| 74HCT7 | 540 | | | | | | | | |
| t _{pd} | propagation delay | An to Yn; see Figure 5 | [1] | | | | | | |
| | | $V_{CC} = 4.5 V$ | | - | 19 | 32 | 40 | 48 | ns |
| | | $V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$ | | - | 16 | - | - | - | ns |
| t _{en} | enable time | OEn to Yn; see Figure 6 | [1] | | | | | | |
| | | $V_{CC} = 4.5 V$ | | - | 19 | 32 | 40 | 48 | ns |
| t _{dis} | disable time | OEn to Yn; see Figure 6 | [1] | | | | | | |
| | | $V_{CC} = 4.5 V$ | | - | 20 | 32 | 40 | 48 | ns |
| t _t | transition time | V_{CC} = 4.5 V; see <u>Figure 5</u> | [2] | - | 5 | 12 | 15 | 18 | ns |
| C _{PD} | power dissipation capacitance | per package; V _I = GND to V _{CC} – 1.5 V | [3] | - | 31 | - | - | - | pF |

Dynamic characteristics Table 7.

GND = 0 V; $C_1 = 50 pE$; for test circuit see Figure 7.

[1] t_{pd} is the same as t_{PLH} and t_{PHL} . t_{en} is the same as t_{PZL} and t_{PZH} . t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW): P_D = $C_{PD} \times V_{CC}{}^2 \times f_i \times N$ + Σ ($C_L \times V_{CC}{}^2 \times f_o)$ where: f_i = input frequency in MHz; $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

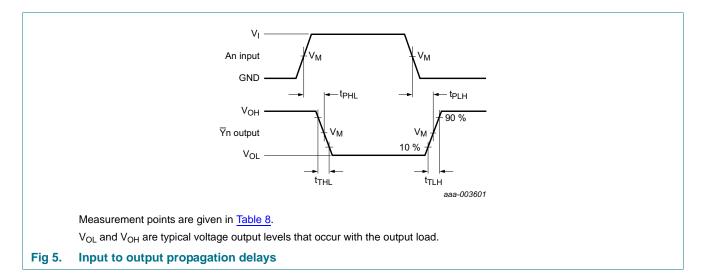
V_{CC} = supply voltage in V;

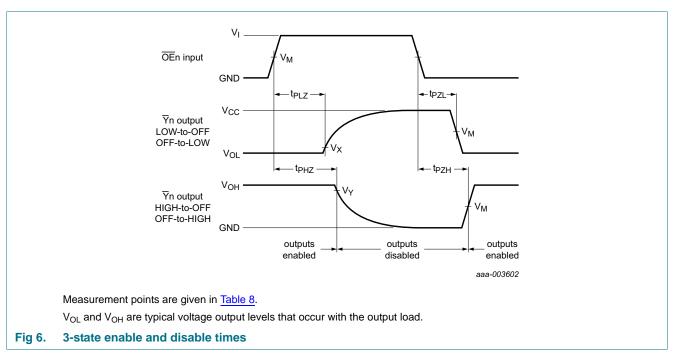
N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

Octal Schmitt trigger buffer/line driver; 3-state; inverting

11. Waveforms





| Table 8. | Measureme | nt points | |
|----------|-----------|-----------|--------|
| Туре | | Input | Output |
| | | | |

| Туре | Input | Output | | | | | | |
|-----------|--------------------|--------------------|--------------------|--------------------|--|--|--|--|
| | V _M | V _M | V _X | V _Y | | | | |
| 74HC7540 | 0.5V _{CC} | 0.5V _{CC} | 0.1V _{CC} | 0.9V _{CC} | | | | |
| 74HCT7540 | 1.3 V | 1.3 V | 0.1V _{CC} | 0.9V _{CC} | | | | |

74HC7540; 74HCT7540

Octal Schmitt trigger buffer/line driver; 3-state; inverting

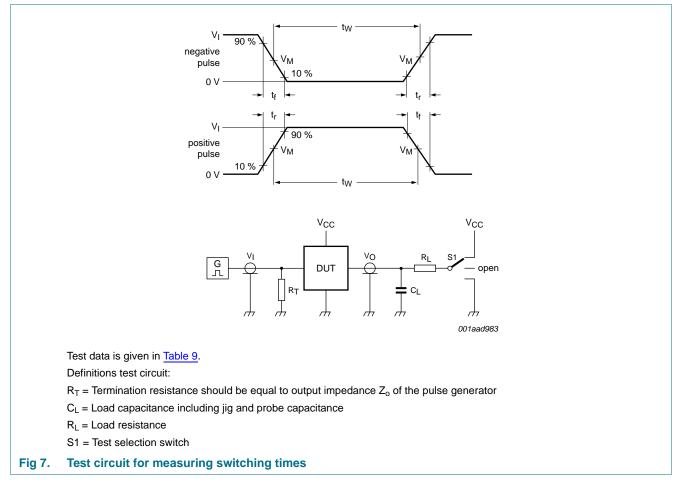


Table 9. Test data

| Туре | Input | | Load | Load | | S1 position | | |
|-----------|-----------------|---------------------------------|--------------|------|-------------------------------------|-------------------------------------|-------------------------------------|--|
| | VI | t _r , t _f | CL | RL | t _{PHL} , t _{PLH} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} | |
| 74HC7540 | V _{CC} | 6 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} | |
| 74HCT7540 | 3 V | 6 ns | 15 pF, 50 pF | 1 kΩ | open | GND | V _{CC} | |

74HC_HCT7540
Product data sheet

Octal Schmitt trigger buffer/line driver; 3-state; inverting

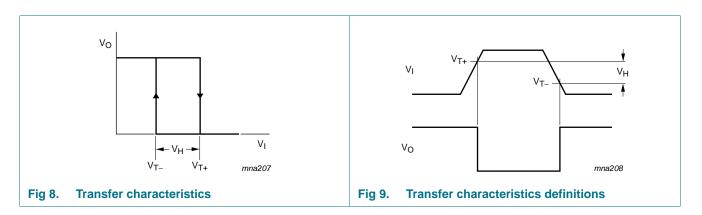
12. Transfer characteristics

Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see Figure 8 and Figure 9.

| Symbol | Parameter | Conditions | T _{ar} | T _{amb} = 25 °C | | T _{amb} = -40 °C to +85 °C | | T _{amb} = -40 °C to +125 °C | | Unit |
|-----------------|--|-------------------------|-----------------|--------------------------|------|--|------|---|------|------|
| | | | Min | Тур | Max | Min | Max | Min | Max | |
| 74HC754 | 40 | | l | | | | I | | | |
| V _{T+} | positive-going threshold voltage | $V_{CC} = 2.0 V$ | - | - | 1.5 | - | 1.5 | - | 1.5 | V |
| | | $V_{CC} = 4.5 V$ | - | - | 3.15 | - | 3.15 | - | 3.15 | V |
| | | $V_{CC} = 6.0 V$ | - | - | 4.2 | - | 4.2 | - | 4.2 | V |
| V_{T-} | negative-going threshold voltage | $V_{CC} = 2.0 V$ | 0.3 | - | - | 0.3 | - | 0.3 | - | V |
| | | $V_{CC} = 4.5 V$ | 1.35 | - | - | 1.35 | - | 1.35 | - | V |
| | | $V_{CC} = 6.0 V$ | 1.8 | - | - | 1.8 | - | 1.8 | - | V |
| V _H | hysteresis voltage | $V_{CC} = 2.0 V$ | 0.1 | 0.20 | - | 0.1 | - | 0.1 | - | V |
| | | $V_{CC} = 4.5 V$ | 0.25 | 0.40 | - | 0.25 | - | 0.25 | - | V |
| | | $V_{CC} = 6.0 V$ | 0.3 | 0.5 | - | 0.3 | - | 0.3 | - | V |
| 74HCT7 | 540 | | | | | | | | | |
| V _{T+} | positive-going threshold voltage | $V_{CC} = 4.5 V$ | - | - | 2.0 | - | 2.0 | - | 2.0 | V |
| | | V _{CC} = 5.5 V | - | - | 2.1 | - | 2.1 | - | 2.1 | V |
| V _{T-} | negative-going threshold voltage | $V_{CC} = 4.5 V$ | 0.7 | - | - | 0.64 | - | 0.6 | - | V |
| | | V _{CC} = 5.5 V | 0.8 | - | - | 0.74 | - | 0.7 | - | V |
| V _H | hysteresis voltage | $V_{CC} = 4.5 V$ | 0.17 | 0.23 | - | - | - | - | - | V |
| | | V _{CC} = 5.5 V | 0.17 | 0.23 | - | - | - | - | - | V |

13. Transfer characteristics waveforms



74HC_HCT7540 Product data sheet

74HC7540; 74HCT7540

Octal Schmitt trigger buffer/line driver; 3-state; inverting

14. Package outline

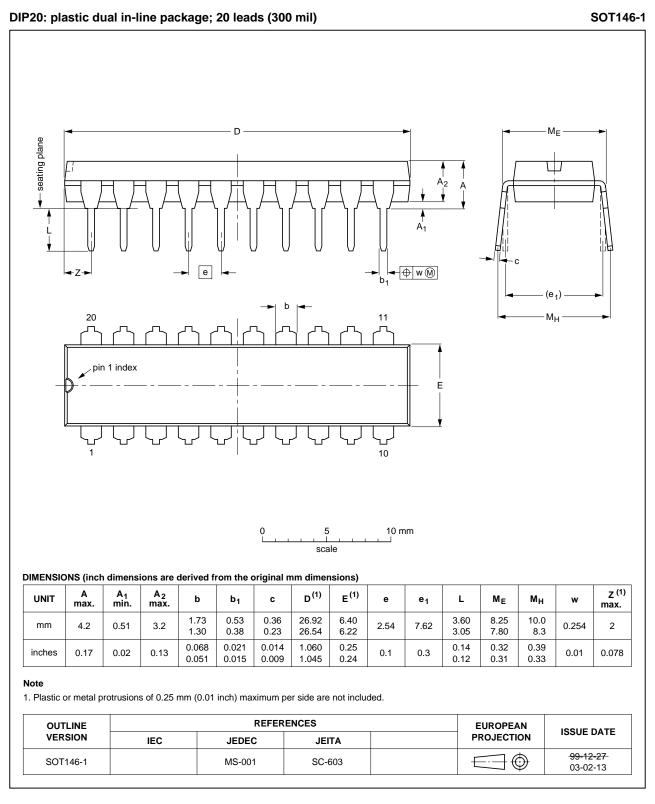


Fig 10. Package outline SOT146-1 (DIP20)

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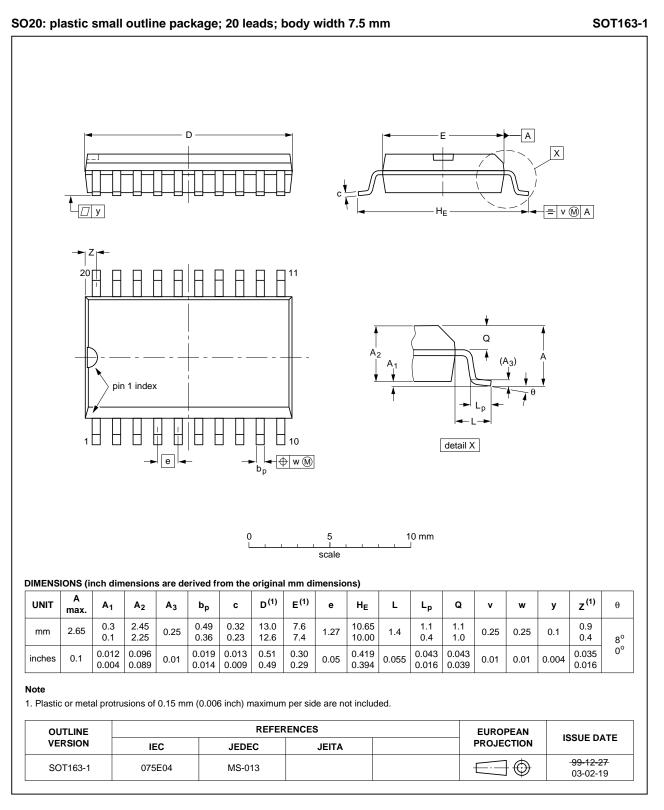


Fig 11. Package outline SOT163-1 (SO20)

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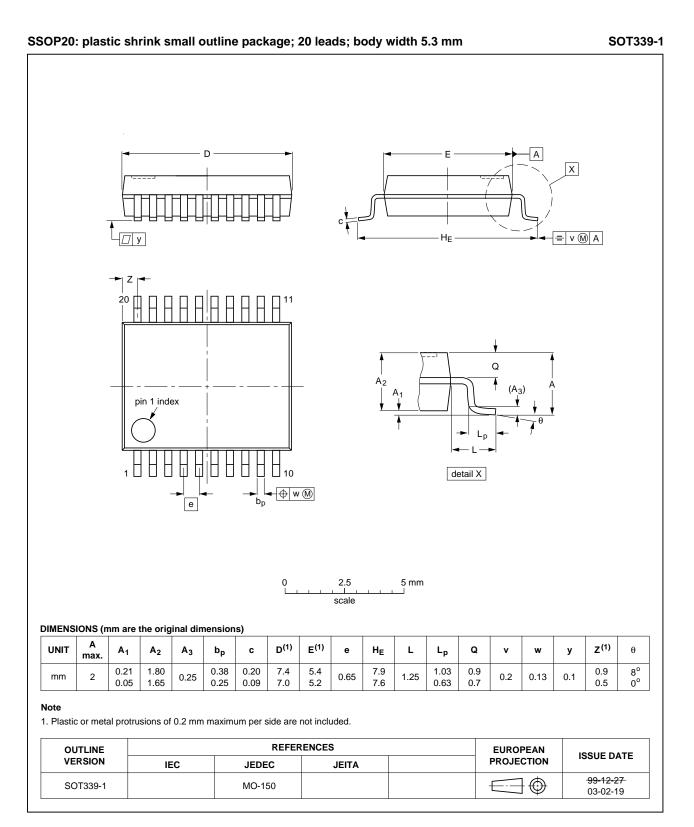


Fig 12. Package outline SOT339-1 (SSOP20)

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Octal Schmitt trigger buffer/line driver; 3-state; inverting

15. Abbreviations

| Table 11. Abbreviations | | | | |
|-------------------------|--|--|--|--|
| Acronym | Description | | | |
| CMOS | Complementary Metal-Oxide Semiconductor | | | |
| DUT | Device Under Test | | | |
| ESD | ElectroStatic Discharge | | | |
| HBM | Human Body Model | | | |
| LSTTL | Low-power Schottky Transistor-Transistor Logic | | | |
| MM | Machine Model | | | |

16. Revision history

| Table 12. | Revision | history |
|-----------|----------|---------|
|-----------|----------|---------|

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------------|---|--|----------------------|-----------------------|
| 74HC_HCT7540 v.4 | 20121231 | Product data sheet | - | 74HC_HCT7540 v.3 |
| Modifications: | I_{OZ} added to | static characteristics table. | | |
| 74HC_HCT7540 v.3 | 20120827 | Product data sheet | - | 74HC_HCT7540_CNV v.2 |
| Modifications: | | of this data sheet has been rec f NXP Semiconductors. | lesigned to comply w | vith the new identity |
| | Legal texts h | have been adapted to the new | company name whe | ere appropriate. |
| 74HC_HCT7540_CNV v.2 | 19970917 | Product specification | - | - |

Octal Schmitt trigger buffer/line driver; 3-state; inverting

17. Legal information

17.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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74HC7540; 74HCT7540

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19. Contents

| 1 | General description 1 |
|------|------------------------------------|
| 2 | Features and benefits 1 |
| 3 | Ordering information 1 |
| 4 | Functional diagram 2 |
| 5 | Pinning information 2 |
| 5.1 | Pinning |
| 5.2 | Pin description 3 |
| 6 | Functional description 3 |
| 7 | Limiting values 3 |
| 8 | Recommended operating conditions 4 |
| 9 | Static characteristics 4 |
| 10 | Dynamic characteristics 5 |
| 11 | Waveforms 7 |
| 12 | Transfer characteristics 9 |
| 13 | Transfer characteristics waveforms |
| 14 | Package outline 10 |
| 15 | Abbreviations 13 |
| 16 | Revision history 13 |
| 17 | Legal information 14 |
| 17.1 | Data sheet status 14 |
| 17.2 | Definitions 14 |
| 17.3 | Disclaimers |
| 17.4 | Trademarks 15 |
| 18 | Contact information 15 |
| 19 | Contents 16 |

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